

Description

The LC03-3.3L is a 3.3V low capacitance TVS array, combining a TVS diode with a rectifier bridge to provide both common and differential transient protection in one package, The LC03-3.3L complies with the IEC 61000-4-2 (ESD) with ±30kV air and ±30kV contact discharge. It is assembled into a 8-pin lead-free SO-8 package, the LC03 -3.3L is rated for GR-1089, intra-building transient immunity requirements for telecommunication installations and provide overvoltage protection for applications such as 10/100/1000 BaseT Ethernet and T3/E3 interfaces.

Features

- Low capacitance for high speed interfaces
- Ultra low leakage: nA level
- Low operating voltage: 3.3V
- Ultra low clamping voltage
- Protects two lines in common and differential mode
- JEDEC SO-8 package
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 Air discharge: ±30kV
 - Contact discharge: ±30kV
 - IEC61000-4-5 (Lightning) 75A (8/20µs)
- RoHS Compliant

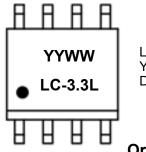
Mechanical Characteristics

- Package: SO-8
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound.
- Terminal Connections: See Diagram Below
- Marking Information: See Below

Applications

- T1/E1 Line Cards
- T3/E3 and DS3 Interfaces
- STS-1 Interfaces
- 10/100/1000 BaseT Ethernet
- Set Top Box
- ISDN Interfaces
- Low Voltage Interfaces

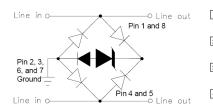
Marking Information

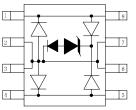


LC-3.3L = Device Marking Code YYWW = Date Code Dot denotes Pin1

Ordering Information

Dimensions and Pin Configuration





Circuit and Pin Schematic

SO-8 Outline

Part Number	Packaging	Reel Size	
LC03-3.3L	2500/Tape & Reel	13 inch	



Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20µs)	Ppk	1875	W
Peak Pulse Current (8/20µs)	IPP	75	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	Vesd	±30 ±30	kV
Operating Temperature Range	TJ	−55 to +125	°C
Storage Temperature Range	Tstg	−55 to +150	°C

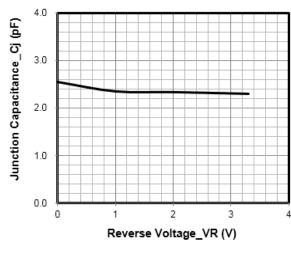
Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			3.3	V	
Punch-Through Voltage	Vpt		4.7		V	Ιτ = 2μΑ
Breakdown Voltage	VBR		5.1		V	IT = 1mA
Snap-Back Voltage	VSB		5.4		V	IT = 50mA
Reverse Leakage Current	I _R			0.5	μA	VRWM = 3.3V
Clamping Voltage	Vc			8	V	IPP = 1A (8 x 20µs pulse), any I/O pin to ground
Clamping Voltage	Vc			25	V	IPP = 75A (8 x 20µs pulse), any I/O pin to ground
Junction Capacitance	CJ		3	5	pF	VR = 0V, f = 1MHz, between I/O pins and ground
Junction Capacitance	CJ		1.5	2.5	pF	VR = 0V, f = 1MHz, between I/O pins

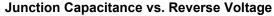
Note 1: I/O pins are Pin 1, 4, 5 and 8

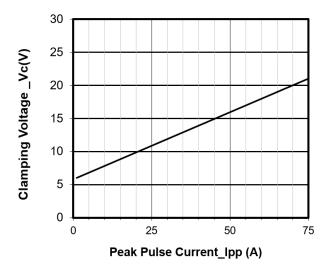


LC03-3.3L

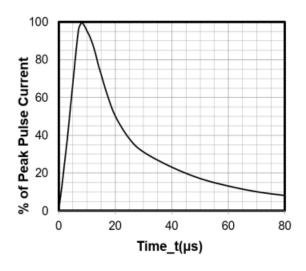


Typical Performance Characteristics (TA=25°C unless otherwise Specified)

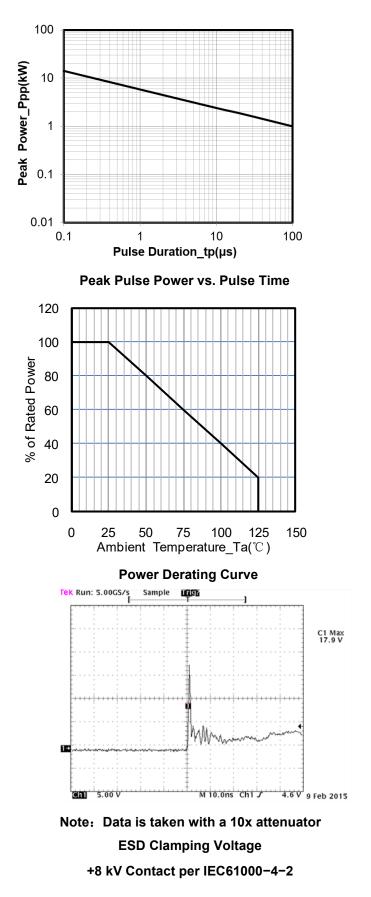




Clamping Voltage vs. Peak Pulse Current



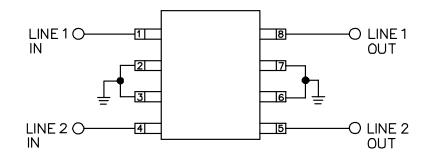
8 X 20µs Pulse Waveform



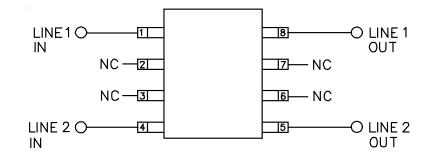


Typical Application

The LC03-3.3L is designed to protect two high speed data lines (one differential pair) from transient over-voltages which result from lightning and ESD. The device can be configured to protect in differential (Line to Line) and common (Line to Ground) mode. Data line inputs/outputs are connected at pins 1 to 8, and 4 to 5 as shown below. Pins 2, 3, 6, 7 are connected to ground. These pins should be connected directly to a ground plane on the board for the best results, the path length is kept as short as possible to minimize parasitic inductance. In applications where high common voltages are present, differential protection is achieved by leaving pins 2, 3, 6, and 7 not connected.



Connection for differential (Line to Line) and common mode protection (Line to Ground)

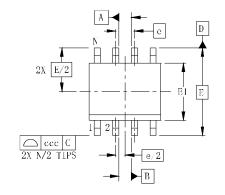


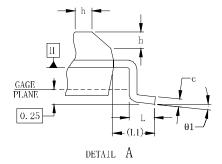
Connection for differential protection (Line to Line)



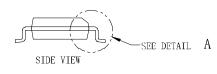
LC03-3.3L

SO-8 Package Outline Drawing



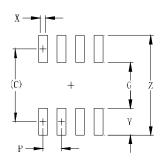


	aaa C	
SEATING PLANE		



	DIMENSIONS							
SY	MILLIMETERS			INCHES				
М	MIN	NOM	MAX	MIN	NOM	MAX		
А	1.35		1.75	0.053		0.069		
A1	0.10		0.25	0.004		0.010		
A2	1.25		1.65	0.049		0.065		
b	0.31		0.51	0.012		0.020		
С	0.17		0.25	0.007		0.010		
D	4.80	4.90	5.00	0.189	0.193	0.197		
E1	3.80	3.90	4.00	0.150	0.154	0.157		
Е	6.00 BSC			0.236 BSC				
е	1.27 BSC			0.050 BSC				
h	0.25		0.50	0.010		0.020		
L	0.40	0.72	1.04	0.016	0.028	0.041		
L1	(1.04)			(0.041)				
Ν	8			8				
θ1	0°		8°	0°		8°		
aaa	0.10			0.004				
bbb	0.25			0.010				
CCC	0.20			0.008				

Suggested Land Pattern



DIMENSIONS SYM MILLIMETERS INCHES С (5.20) 0.205 0.118 G 3.00 Ρ 1.27 0.050 Х 0.60 0.024 Υ 2.20 0.087 Ζ 7.40 0.291

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